

Docket No.: 245537US0

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

RE: Application Serial No.: 10/713,163

Applicants: Toshio SHIOBARA, et al.

Filing Date: November 17, 2003

For: WAFER DICING/DIE BONDING SHEET

Group Art Unit: 1711

SIR:

Attached hereto for filing are the following papers:

Status Request First Office Action (in duplicate)

Our check in the amount of \$0 is attached covering any required fees. In the event any variance exists between the amount enclosed and the Patent Office charges for filing the above-noted documents, including any fees required under 37 C.F.R 1.136 for any necessary Extension of Time to make the filing of the attached documents timely, please charge or credit the difference to our Deposit Account No. 15-0030. Further, if these papers are not considered timely filed, then a petition is hereby made under 37 C.F.R. 1.136 for the necessary extension of time. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Toshio SHIOBARA, et al.

SERIAL NO: 10/713,163

GROUP NO: 1711

FILED:

November 17, 2003

FOR:

WAFER DICING/DIE BONDING SHEET

FIRST OFFICE ACTION STATUS REQUEST

Commissioner for Patents Alexandria, VA 22313-1450

Sir:

The Patent Office is respectfully requested to inform the undersigned of the approximate date a first Official Action will be issued in this Application.

A duplicate of this letter is enclosed for your convenience.

Respectfully Submitted,

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